



01-14-02

Atty. Docket No. AMAT/6060/CALB/COPPER/PJS

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Box Patent Application
Assistant Commissioner of Patents and Trademarks
Washington, D.C. 20231

10/04/2002 pro
10/08/02

Re: Inventor(s): DONALD J.K. OLGADO; AVI TEPMAN; DMITRY LUBOMIRSKY and
TIMOTHY R. WEBB
Title: SYSTEM FOR PLANARIZING METAL CONDUCTIVE LAYERS

Transmitted herewith is the patent application identified above, including:

- Specification, claims and abstract, totaling 35 pages.
 Drawings totaling 10 pages, Formal Informal.
 Executed Declaration and Power of Attorney.
 Information Disclosure Statement w/ Form 1449 and References.
 Assignment of the invention to **Applied Materials, Inc.**
 Assignment Recordation Cover Sheet

FEE CALCULATION

Fee Items	Claims Filed	Included With Basic Fee	Extra Claims	Fee Rate	Total
Total Claims	46	-20=	26	x \$18.00	--468.00
Independent Claims	11	-3=	8	x \$84.00	--672.00
Basic Filing Fee				\$740.00	\$740.00
TOTAL FEES					\$1,880.00

The Commissioner is hereby authorized to charge \$1,880.00 to Deposit Account No. 50-1074/6060/CALB/COPPER/PJS/RWM.

The Commissioner is hereby authorized to charge any additional fees which may be required, or credit any overpayment to Deposit Account No. 50-1074/6060/CALB/COPPER/PJS/RWM. A duplicate copy of this transmittal is enclosed.

Please address all future correspondence to:

**PATENT COUNSEL
APPLIED MATERIALS, INC.
Legal Affairs Department
P.O.BOX 450A
Santa Clara, CA. 95052**

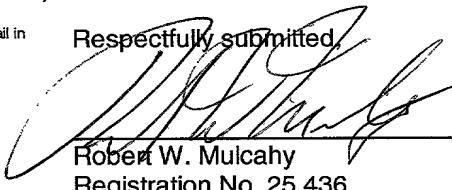
I hereby certify that this correspondence is being deposited with the United States Postal Service as express mail in an envelope addressed to: Commissioner of Patents and Trademarks, Washington, D.C. 20231.

Express Mail Receipt No. EV041915839US

Date of Deposit 1-8-02

Signature Robert W. Mulcahy

Respectfully submitted,


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